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## 4900 UNIVERSAL AUTOMATED PROGRAMMING SYSTEM

Setting the Standard in Device Programming

PRODUCT SPECIFICATION SHEET 4900 AUTOMATED PROGRAMMING SYSTEM



### POWERED BY 9TH GENERATION PROGRAMMING TECHNOLOGY



High throughput, fast changeover, and extreme flexibility, the **4900 delivers the quality and reliability customers count on**, for the most demanding production requirements.

#### 4900 Delivers Reliable, Fast, and Accurate Production Programming Performance

#### **Unmatched Programming Speed**

- High programming speed for MCUs, eMMC, NAND, NOR and Serial Flash
- Up to 100MBytes/s for the industry's fastest program /verify times
- Download image files up to 25MB/s to all programmers simultaneously
- Faster programming times reduces investment in the number of systems, sites and sockets you need to buy
- Up to 9 times faster than competing universal programmers
- The Largest Memory Support in the industry - 512GB
- As newer and faster devices are introduced onto the market, 9THGEN Vector Engine Co-Processor® technology adapts to the faster speeds, delivering more value with improved performance

#### Complete Ecosystem

BPM has ownership of all designs, manufacturing and support for all programming sites, robotics, vision systems, and software so we can provide unmatched support and responsiveness.

#### **Device Support Without Limits**

- True universal support One solution for all your programming requirements
- Programming a wider range of devices on the same socket reduces tooling and job change over costs
- Compatible with existing 7th and 8th generation socket cards and algorithms, 9THGEN offers a large library of current support while reducing cost and time to market for future support with the use of existing socket designs
- Low cost replaceable socket designs combined with fast programming speeds provides the lowest cost per device
- IP protection with data encryption and advanced serialization options ensures that your data is easily managed and secured

#### **Production Capabilities that Deliver**

- Fine-pitch automated device handling with vision alignment delivers proven performance
- Up to twelve 9THGEN Programming sites, with up to 48 individual Socket Cards
- Flexible options for input and output media with choices of automated tape, tray and tube
- Marking options include laser, label and the ID-PRO ink-based conformation marking system
- 3D vision option which inspects BGA, CSP, QFP, TSOP, SOIC and J-Lead devices for coplanarity, bent lead, pitch, width, diameter, standoff and XY errors
- Software API tools Allows tight integration with your manufacturing process for inventory control and process management
- Reduce your time to market by doing new product introduction/first article through automated production with the same hardware, algorithms and software.
- 1900 for Fast First Articles, 2900 for Manual Production, 3900 and 4900 for Automated Production

### 4900 UNIVERSAL AUTOMATED PROGRAMMING SYSTEM

#### **Product Specifications**

	- Froduct 5		
PICK & PLACE SYSTEM		PROGRAMMING HARDWARE	
Handler Throughput: Component Handling Range: Laser Alignment: Placement Accuracy: Placement Repeatability: Placement Force: Dimensions: Shipping Weight:	up to 1500DPH SOT23 to 240-pin QFP component range - SOT23 ± 0.0012" (0.06mm) ± 0.0024" (0.03mm) 60-600 grams positional control length 42" (106.6cm), width with laser 63" (160.2cm) width without laser 42" (106.2cm), height with light tower 72" (182.8cm) 182kg	Architecture: Programming Sites: Calibration: Diagnostics:	9THGEN Concurrent Programming System with Vector Engine Co-Processor Up to 12 sites, 1 to 4 sockets per site annual, may be performed on site RAM, communications, calibration, timing, LEDs, fans, pinoe, power supplies, voltage/current/slew for vpp and vcc, high cur- rent vcc mode, digital pin drivers, and relays. Ground Transistors, digital driver path to pro- grammer, dcard LEDs, customizable diagnostic per dcard.
Shipping Dimensions: Self Test:	length 48" (122cm), width 48 (122cm), height 69" (175cm) power supplies, CPU, memory, X, Y, Z, theta	Memory: Communications: Data Pattern Broadcast: Firmware Updates:	512GB per site USB 2.0 25MB/s Software automatically performs
	motion systems, spindle run-out and height, vacuum system	· · · · ·	firmware download
DOCITIONING CVCTEM	· ···· · · · · · · · · · · · · · · · ·	PIN DRIVERS	
POSITIONING SYSTEM X-Y Drive System:	high-performance stepper motor driven precision belt	Quantity: Vpp Range: Ipp Range:	240-pins standard, per site 0V to 25V Up to 1.2A total
X-Y Encoder Type: X-Y Axis Resolution: X-Y Axis Maximum Velocity: Z Drive System:	İinear optical scale 0.0002" (0.0050mm) 30" /sec (76cm/s) high-performance stepper motor driven	Vcc Range: Icc Range: Rise Time:	0V to 13V 0-2A 4ns
Placement Accuracy: Z axis Resolution: Z axis Repeatability: Theta Drive System:	lead screw 90μ@ 4 sigma, 67μ@ 3 sigma ± 0.001" (0.025mm) ± 0.0015" (0.038mm) precision stepper motor-driven direct anti-	Protection: Independence: Digital Range: Clocks:	overcurrent shutdown, power failure shutdow pin drivers and waveform generators are fully independent and concurrent on each site 0-4.5V 800kHz to 64MHz
Theta Axis Resolution:	backlash twin gear assembly 0.015°	SOFTWARE	
Theta Axis Repeatability:	+/- 0.2mm	Required: File Type:	BPWin binary, Intel, Motorola, RAM, straight hex, hex
VISION SYSTEM Type: Component Location Resolution:	Cyberoptics® LaserAlign™ 1 micron	гие туре.	space, Tekhex, Extended Tekhex, ASCII, hex, OMF, LOF, MER and others ID check, blank check, continuity, auto start,
SYSTEM REQUIREMENTS Air Pressure:	80psi (5.56 bars) minimum	Device Processes:	compare, read, erase, program, verify, multi- pass verify, test, checksum, secure, device con-
Air Flow: Operational Temperature: Relative Humidity: Minimum Floor Space:	2.0scfm (50.1L/min) 55° to 90° F (13° to 32° C) 30-80% length 183cm x width 107cm	Operating Systems: Network Interface:	figure, auto-range, options and more Windows XP Professional, Windows 7 32bit Gigabit Ethernet
Input Line Voltage:	100-130/200-260VAC	PERIPHERAL OPTIONS	
Input Line Frequency: Power Consumption: SOCKET OPTIONS	50/60 Hz 1KVA	Peripherals:	Tape I/O, Tray Stacker, Tray Shuttle, Tube I/O, Laser Marker, Labeler. ID-PRO® ink- based confirmation marking system
Socket Modules:	Support for existing FX and FVE socket	WADDANTY	
	modules. Universal 1900/2900 socket cards with 144 universal pins. Available Socket Cards including, but not limited to, stan- dard PLCC, CSP, BGA, μBGA, SOIC, QFN, MLF, LAP, QFP, TSOP, LCC, SDIP, SIMM Other Options: Advanced Feature Soft- ware, simple and complex serialization,	WARRANTY Hardware: Software:	One Year Hardware Warranty One Year Software Support



CJob, Monitor and CJob Control (API),

EDGE<sup>™</sup> High Performance Socket Cards

**Receptacle Socket options,** 

#### Setting the Standard in Device Programming

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